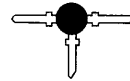


# 7.5 Volts Transistor

88 MHz

19 dB GAIN

Using the most recent TRW technology, this T-Pack transistor has been specifically designed and characterized as a high gain 7.5 V VHF device. It is ideally suited for use in pocketphone applications where low battery voltage is used.

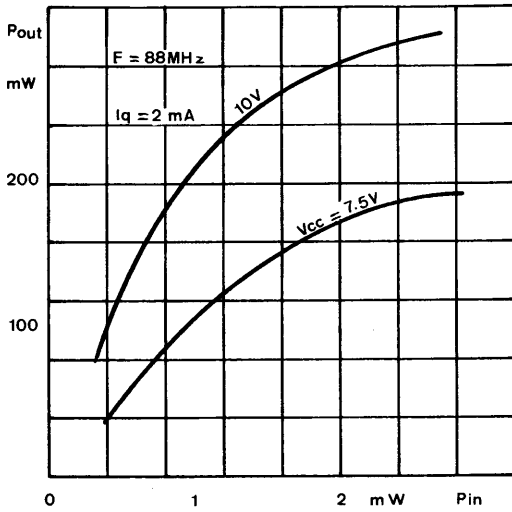


T - PACK

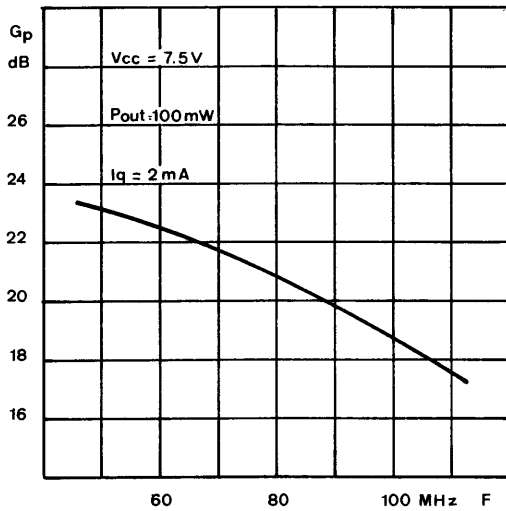
### Preliminary

	SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
DC TEST	$BV_{EBO}$	Emitter Base Breakdown Voltage	$I_E = 0.1 \text{ mA}$ $I_C = 0$	3			V
	$BV_{CEO}$	Collector Emitter Breakdown Voltage	$I_C = 10 \text{ mA}$ $I_B = 0$	20			V
	$BV_{CER}$	Collector Emitter Breakdown Voltage	$I_C = 10 \text{ mA}$ $R_{BE} = 10 \Omega$	25			V
	$BV_{CBO}$	Collector Base Breakdown Voltage	$I_C = 1 \text{ mA}$ $I_E = 0$	30			V
	$H_{FE}$	DC Current Gain	$V_{CB} = 10 \text{ V}$ $I_C = 40 \text{ mA}$	15			—
RF TEST	$P_{GAIN}$	Power Gain	$V_{CE} = 7.5 \text{ V}$ $I_C = 2 \text{ mA}$ $P_{in} = 1 \text{ mW}$ $F = 88 \text{ MHz}$	80			mW
	$F_T$	Cutoff Frequency	$V_{CE} = 10 \text{ V}$ $I_C = 40 \text{ mA}$ $F = 100 \text{ MHz}$		2		GHz
	$G_{Umax}$	Maximum unilateralized Gain	$V_{CE} = 10 \text{ V}$ $I_C = 40 \text{ mA}$ $F = 100 \text{ MHz}$		26		dB
	$S_{21}$	Forward Gain 50 $\Omega$ /50 $\Omega$	$V_{CE} = 10 \text{ V}$ $I_C = 40 \text{ mA}$ $F = 100 \text{ MHz}$		24		dB
	$C_{ob}$	Collector Base Capacitance	$V_{CB} = 10 \text{ V}$ $F = 1 \text{ MHz}$		2.5		pF
OPERATING THERMAL	$I_{Cmax}$	Maximum Collector Current				200	mA
	$P_T$	Dissipated Power	$T_{case} = 50 \text{ }^\circ\text{C}$			0.6	W
	$T_{STG}$	Storage Temperature					
	$T_J$	Junction Temperature		- 65°		+ 200	°C

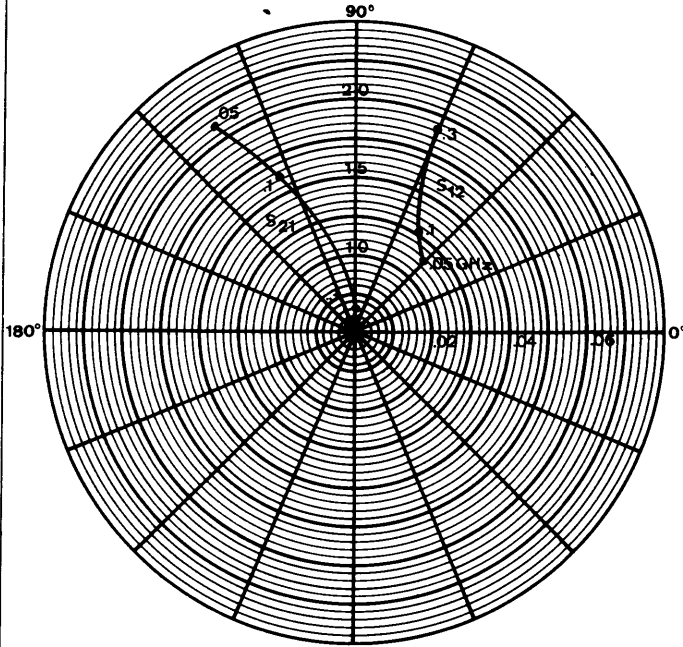
**Output Power vs Frequency and Voltage Supply**



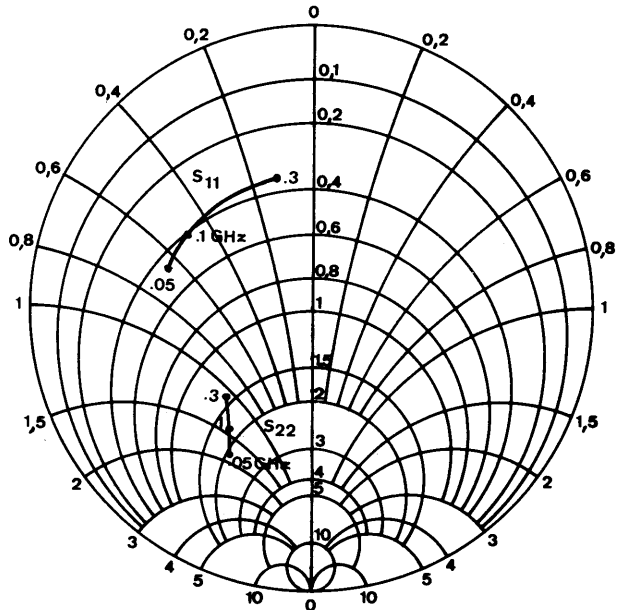
**Power Gain vs Frequency**



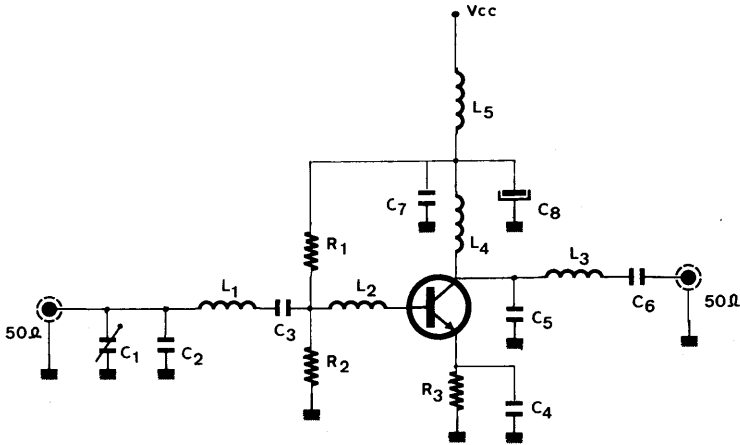
S21 - S12 Parameters vs Frequency  
 $V_{CE} = 10\text{ V} - I_C = 40\text{ mA}$



S11 - S22 Parameters vs Frequency  
 $V_{CE} = 10\text{ V} - I_C = 40\text{ mA}$



88 MHz Test Circuit

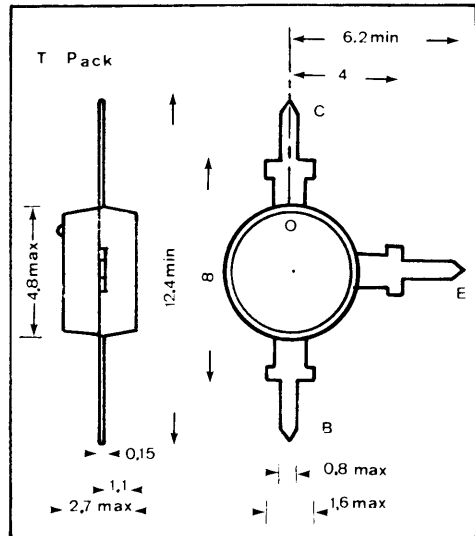


- C<sub>1</sub> = 6-60 pF Trimmer Capacitor
- C<sub>2</sub> = 22 pF Ceramic
- C<sub>3</sub> = 180 pF Ceramic
- C<sub>4</sub> = C<sub>7</sub> = 1 nF Ceramic
- C<sub>5</sub> = 18 pF
- C<sub>6</sub> = 220 pF
- C<sub>8</sub> = 1 μF Electrolytic

- L<sub>1</sub> = L<sub>2</sub> = 0.1 μH Molded Coil
- L<sub>3</sub> = 0.18 μH Molded Coil
- L<sub>4</sub> = 0.22 μH Molded Coil
- L<sub>5</sub> = 1.2 μH Molded Coil

- R<sub>1</sub> = 680 Ω Carbon composition
- R<sub>2</sub> = 56 Ω Carbon composition
- R<sub>3</sub> = 4.7 Ω Carbon composition

Package Outline

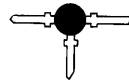


### 7.5 Volts Transistor

400 - 512 MHz

12 dB GAIN

Using the most recent TRW technology, this T-Pack transistor has been specifically designed and characterized as a high gain 7.5 V VHF device. It is ideally suited for use in pocketphone applications where low battery voltage is used.

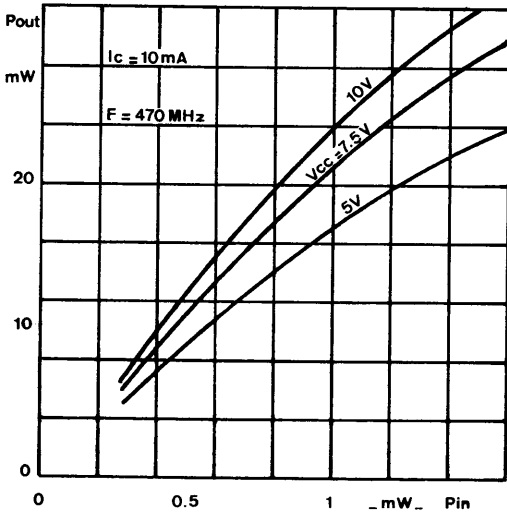


T - PACK

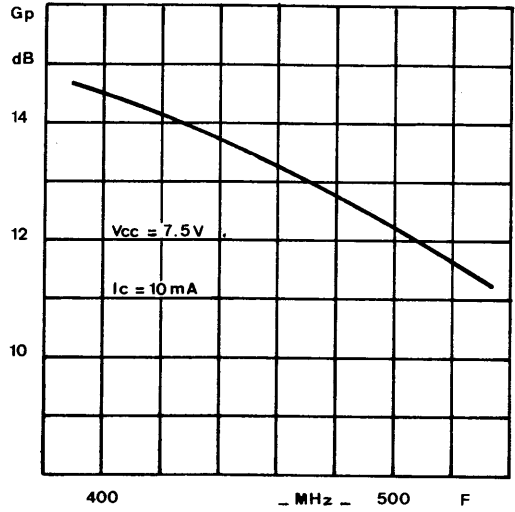
**Preliminary**

	SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
DC TEST	BV <sub>EBO</sub>	Emitter Base Breakdown Voltage	I <sub>E</sub> = 0.1 mA    I <sub>C</sub> = 0	3			V
	BV <sub>CEO</sub>	Collector Emitter Breakdown Voltage	I <sub>C</sub> = 10 mA    I <sub>B</sub> = 0	18			V
	BV <sub>CER</sub>	Collector Emitter Breakdown Voltage	I <sub>C</sub> = 10 mA    R <sub>BE</sub> = 10 Ω	30			V
	BV <sub>CBO</sub>	Collector Base Breakdown Voltage	I <sub>C</sub> = 1 mA    I <sub>E</sub> = 0	35			V
	H <sub>FE</sub>	DC Current Gain	V <sub>CE</sub> = 10 V    I <sub>C</sub> = 40 mA	15			—
RF TEST	P <sub>GAIN</sub>	Power Gain	V <sub>CE</sub> = 7.5 V    P <sub>in</sub> = 1 mW I <sub>C</sub> = 10 mA    F = 470 MHz	15			mW
	F <sub>T</sub>	Cut-off Frequency	V <sub>CE</sub> = 10 V    F = 500 MHz I <sub>C</sub> = 40 mA		2.5		GHz
	G <sub>U max</sub>	Maximum Unilateralized Gain	V <sub>CE</sub> = 10 V    F = 500 MHz I <sub>C</sub> = 40 mA		14		dB
	S <sub>21</sub>	Forward Gain 50 Ω/50 Ω	V <sub>CE</sub> = 10 V    F = 500 MHz I <sub>C</sub> = 40 mA		12.5		dB
	C <sub>ob</sub>	Collector Base Capacitance	V <sub>CB</sub> = 10 V    F = 1 MHz		2.5		pF
OPERATING	I <sub>C max</sub>	Maximum Collector Current				200	mA
	P <sub>T</sub>	Dissipated Power	T <sub>case</sub> = 50 °C			0.6	W
	T <sub>STG</sub>	Storage Temperature					
	T <sub>J</sub>	Junction Temperature		- 65		+ 200	°C

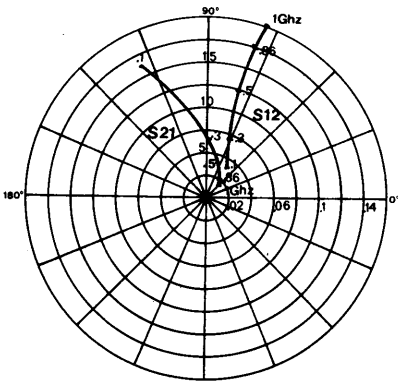
Output Power vs Input Power and Voltage Supply



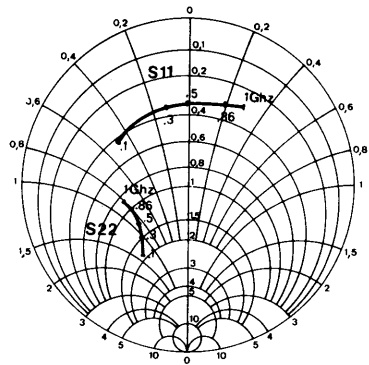
Power Gain vs Frequency



S21 - S12 Parameters vs Frequency  
 $V_{CE} = 10\text{V} - I_C = 40\text{mA}$

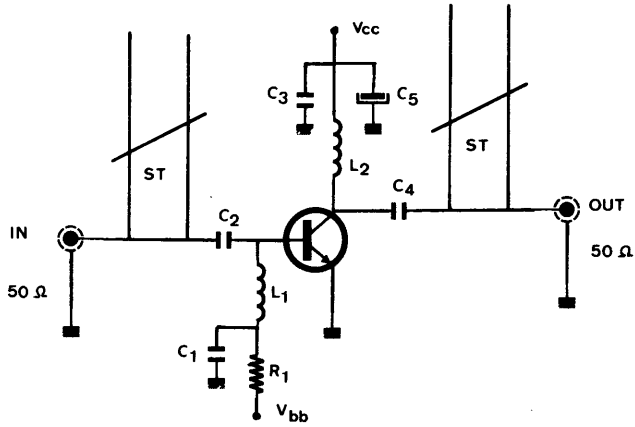


S11 - S22 Parameters vs Frequency  
 $V_{CE} = 10\text{V} - I_C = 40\text{mA}$



TYPICAL VALUE

Test Circuit 400-512 MHz

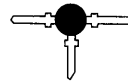


- L<sub>1</sub> = L<sub>2</sub> = 0.33 μH Molded coil
- C<sub>1</sub> = C<sub>2</sub> = C<sub>3</sub> = C<sub>4</sub> = 1000 pF Ceramic chip
- C<sub>5</sub> = 10 μF/25 V Electrolytic
- R<sub>1</sub> = 10 kΩ 1/2 W Carbon composition
- ST = Stub tuner

### UHF LINEAR TRANSISTOR

The TP 312 is a NPN transistor, gold metallized for reliability, using diffused ballast resistors for super linearity at low currents compatible with the power dissipation capability of a T-pack. TP 312 is the ideal candidate for up to **0.7 V** (DIN 45004/B) **MATV** amplifiers from **40 to 860 MHz**. The TP 312 has applications in driver stages of 12 volts VHF/UHF transmitters and broadband instrumentation equipment.

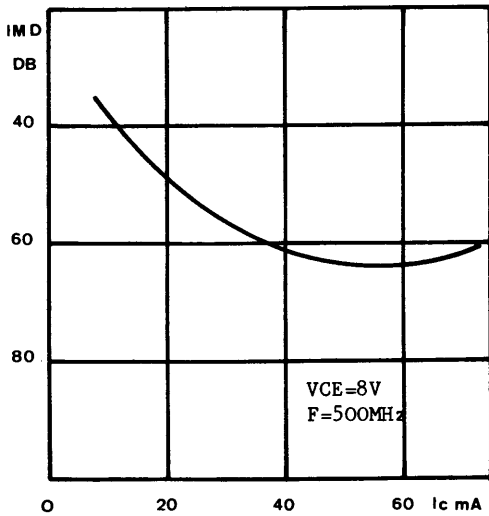
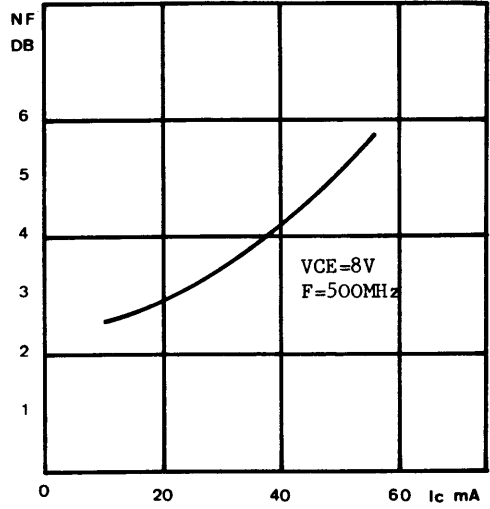
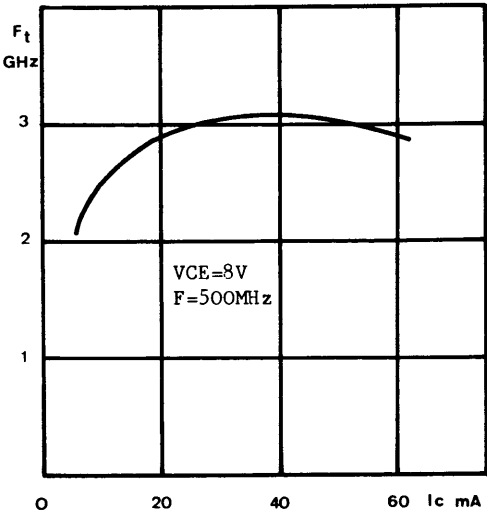
**HIGH OUTPUT  
AT LOW COST  
0.7 V AT - 60 DB IMD  
GOLD RELIABILITY  
3 GHz Ft**



#### Electrical Characteristics (T<sub>flange</sub> = 25 °C)

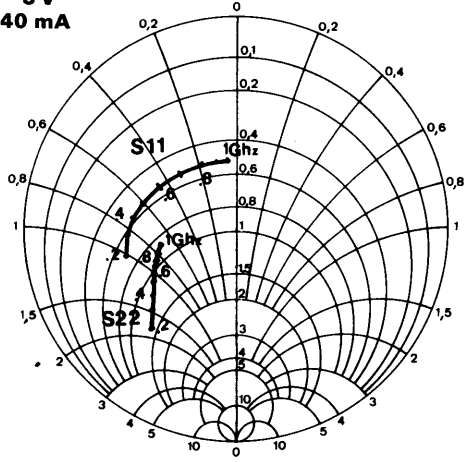
	SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
DC Test	BV <sub>EBO</sub>	Emitter - Base Breakdown Voltage	I <sub>E</sub> = 0.1 mA	3.5			V
	BV <sub>CEO</sub>	Collector - Emitter Breakdown Voltage	I <sub>C</sub> = 10 mA	14			V
	BV <sub>CER</sub>	Collector - Emitter Breakdown Voltage	I <sub>C</sub> = 10 mA R <sub>BE</sub> = 10 ohms	20			V
	BV <sub>CBO</sub>	Collector - Base Breakdown Voltage	I <sub>C</sub> = 0.1 mA	20			V
	h <sub>FE</sub>	D.C. Current Gain	V <sub>CE</sub> = 8 V I <sub>C</sub> = 40 mA	15			
RF Test	NF	Noise Figure	V <sub>CE</sub> = 8 V I <sub>C</sub> = 40 mA F = 500 MHz		4.5		dB
	f <sub>T</sub>	Cutoff Frequency	V <sub>CE</sub> = 8 V I <sub>C</sub> = 40 mA F = 500 MHz		3		GHz
	G <sub>Umax</sub>	Maximum Unilateralized Gain	V <sub>CE</sub> = 8 V I <sub>C</sub> = 40 mA F = 500 MHz		13.5		dB
	S <sub>21</sub>	Forward Gain 50 Ω/50 Ω	V <sub>CE</sub> = 10 V I <sub>C</sub> = 40 mA F = 500 MHz		12		dB
	IMD	Intermodulation Distortion 3 Tone - Din 45004/B F = 500 MHz R <sub>LOAD</sub> = 75 ohms	V <sub>CE</sub> = 8 V V <sub>out</sub> = 700 mV I <sub>C</sub> = 40 mA		- 60		dB
	C <sub>OB</sub>	Collector - Base Capacitance	V <sub>CE</sub> = 8 V f = 1 MHz		1.7		pF
Thermal	I <sub>Cmax</sub>	Maximum Collector Current				300	mA
	P <sub>T</sub>	Dissipated Power				0.7	W
	T <sub>STG</sub>	Storage Temperature					
	T <sub>J</sub>	Junction Temperature		- 65		+ 200	°C





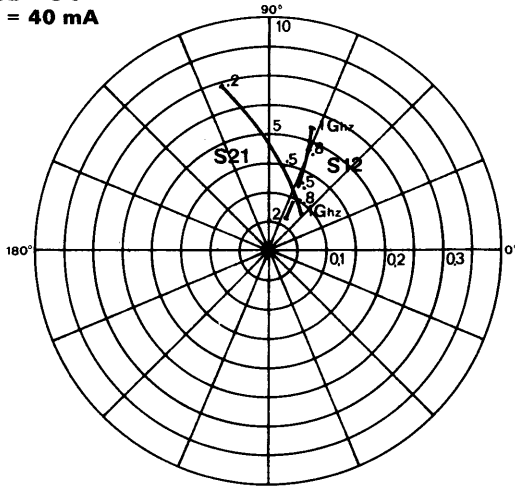
**S11-S22 VS FREQUENCY**

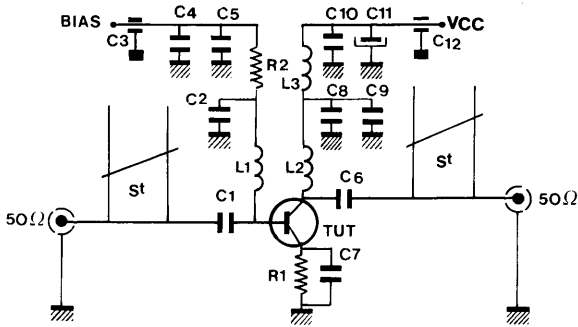
**VCE = 8 V**  
**IC = 40 mA**



**S12-S21 VS FREQUENCY**

**VCE = 8 V**  
**IC = 40 mA**

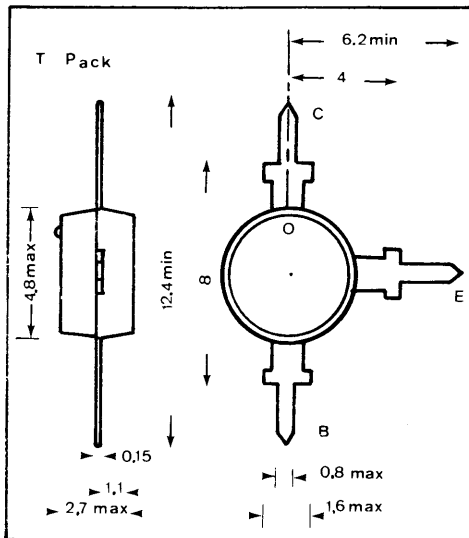




**NF AND GAIN TEST CIRCUIT  
SCHEMATIC**

- L<sub>1,2</sub> 0.02  $\mu$ H
- L<sub>3</sub> 0.1  $\mu$ H - molded coil
- C<sub>1,6</sub> 220 pF ceramic chip
- C<sub>2,4,8</sub> 470 pF ceramic disc
- C<sub>3,12</sub> 1000 pF by pass
- C<sub>5,9</sub> 1000 pF ceramic disc
- C<sub>7</sub> 470 pF ceramic chip
- C<sub>11</sub> 100  $\mu$ F/25 V - electrolytic
- R<sub>1</sub> 100 ohms 1/4 W carbon composition
- R<sub>2</sub> 1.5 K 1/4 W carbon composition
- St Stub tuner

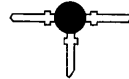
**PACKAGE OUTLINE**



## UHF LINEAR TRANSISTOR

3 DB NOISE FIGURE  
AT 500 MHz  
3 GHz  $f_T$   
LOW COST

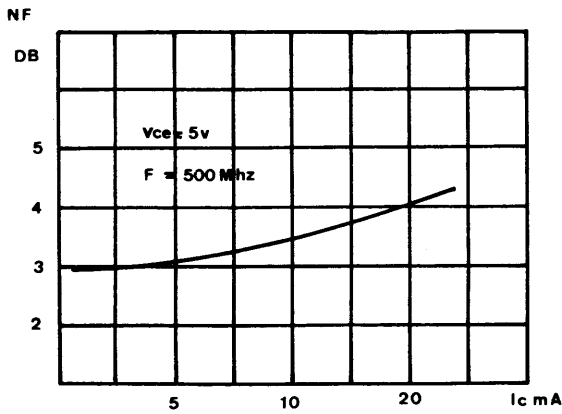
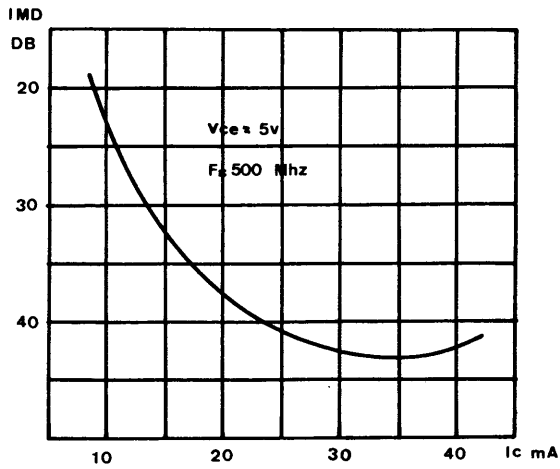
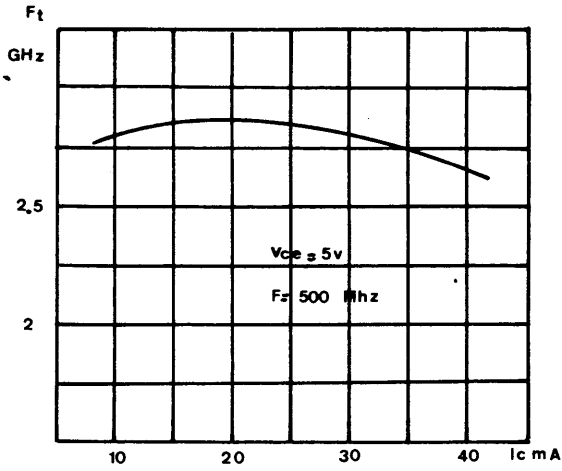
The TP 390 is a low level NPN silicon transistor mounted in T-pack for low cost. Its 3 GHz transition frequency makes it an ideal candidate for broadband UHF linear applications such as in small signal MATV amplifiers from 40 to 860 MHz. TP 390 has applications in most VHF/UHF amplifiers such as instrumentation and communications equipments.



T PACK

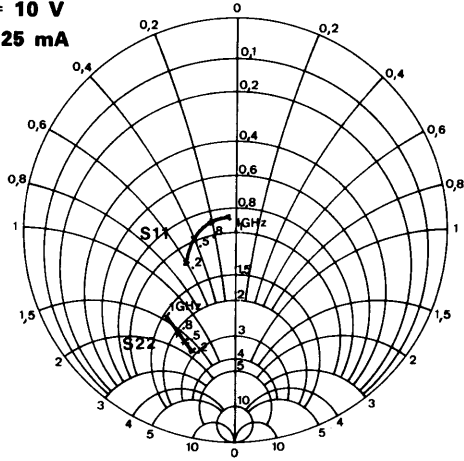
### Electrical Characteristics ( $T_{\text{flange}} = 25\text{ }^\circ\text{C}$ )

	SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
DC Test	$BV_{EBO}$	Emitter - Base Breakdown Voltage	$I_E = 0.1\text{ mA}$	2.5			V
	$BV_{CEO}$	Collector - Emitter Breakdown Voltage	$I_C = 10\text{ mA}$	15			V
	$BV_{CBO}$	Collector - Base Breakdown Voltage	$I_C = 0.1\text{ mA}$	25			V
	$I_{CBO}$	Collector - Base Leakage	$V_{CB} = 10\text{ V}$			0.05	$\mu\text{A}$
	$h_{FE}$	D.C. Current Gain	$V_{CE} = 1\text{ V}$ $I_C = 25\text{ mA}$	20			
RF Test	NF	Noise Figure	$V_{CE} = 5\text{ V}$ $I_C = 2\text{ mA}$ $F = 500\text{ MHz}$		3		dB
	$f_T$	Cutoff Frequency	$V_{CE} = 5\text{ V}$ $I_C = 25\text{ mA}$ $F = 500\text{ MHz}$		2.8		GHz
	$G_{Umax}$	Maximum Unilateralized Gain	$V_{CE} = 10\text{ V}$ $I_C = 25\text{ mA}$ $F = 500\text{ MHz}$		13.5		dB
	$ S_{21} $	Forward Gain 50 $\Omega$ /50 $\Omega$	$V_{CE} = 10\text{ V}$ $I_C = 25\text{ mA}$ $F = 500\text{ MHz}$		11.5		dB
	IMD	Intermodulation Distortion 3 Tone - Din 45004/B $F = 500\text{ MHz}$ $R_{LOAD} = 75\text{ ohms}$	$V_{CE} = 5\text{ V}$ $I_C = 30\text{ mA}$ $V_{out} = 700\text{ mV}$		-40		dB
	$C_{OB}$	Collector - Base Capacitance	$V_{CB} = 10\text{ V}$ $f = 1\text{ MHz}$		0.7		pF
Thermal	$I_{Cmax}$	Maximum Collector Current				50	mA
	$P_T$	Dissipated Power				180	mW
	$T_{STG}$	Storage Temperature					
	$T_J$	Junction Temperature		-65		+200	$^\circ\text{C}$



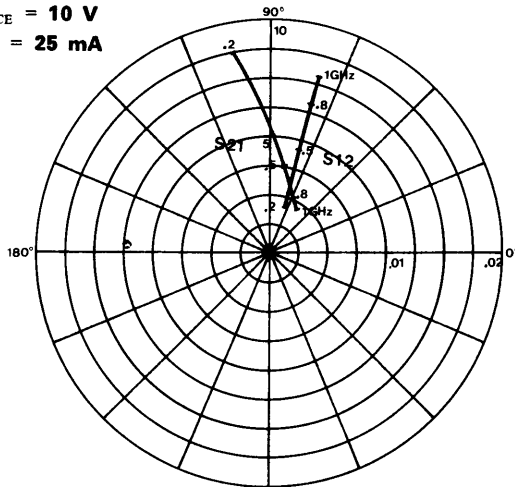
S 11 - S 22 PARAMETERS VS FREQUENCY

$V_{CE} = 10\text{ V}$   
 $I_C = 25\text{ mA}$

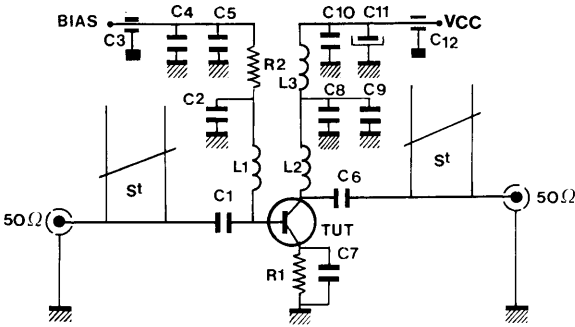


S 21 - S 12 PARAMETERS VS FREQUENCY

$V_{CE} = 10\text{ V}$   
 $I_C = 25\text{ mA}$

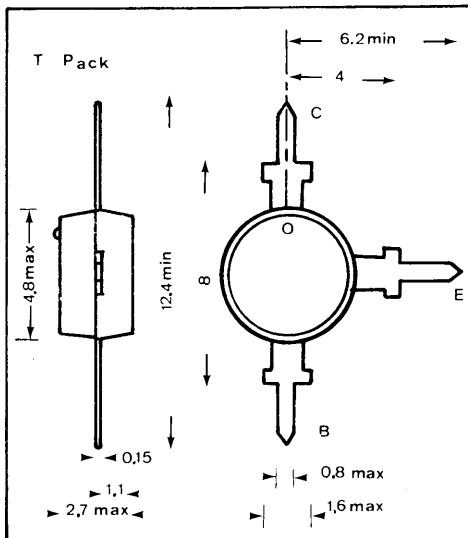


**NF AND GAIN TEST CIRCUIT  
SCHEMATIC**



- $L_{1,2}$  0.02  $\mu$ H
- $L_3$  0.1  $\mu$ H - molded coil
- $C_{1,6}$  220 pF ceramic chip
- $C_{2,4,8}$  470 pF ceramic disc
- $C_{3,12}$  1000 pF by pass
- $C_{5,9}$  1000 pF ceramic disc
- $C_7$  470 pF ceramic chip
- $C_{11}$  100  $\mu$ F/25 V - electrolytic
- $R_1$  100 ohms 1/4 W carbon composition
- $R_2$  1.5 K 1/4 W carbon composition
- St Stub tuner

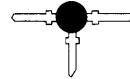
**PACKAGE OUTLINE**



## UHF LINEAR TRANSISTOR

The TP 393 is a gold metallized NPN silicon transistor specifically designed for low noise, high frequency broadband operation. It is mounted in T-pack for high volume low cost applications. These characteristics make it an ideal choice for low noise, intermediate level **MATV/CATV** amplifiers from **40 to 860 MHz**. TP 393 has applications in low noise **receivers** and **mixers** up to **2.5 GHz** in radio or cable communication, doppler radars and instrumentation equipment.

2 DB NOISE FIGURE  
AT 500 MHz  
3 GHz FT  
HIGH OUTPUT

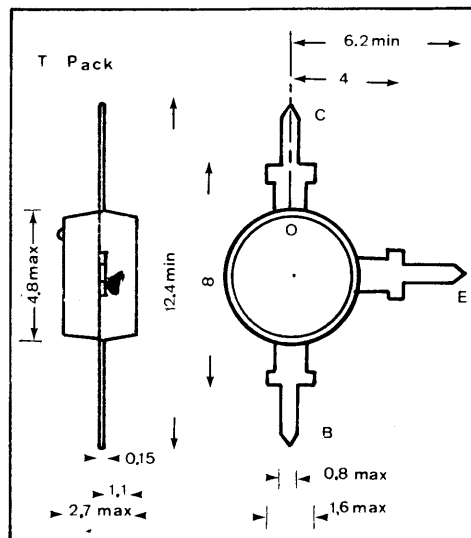
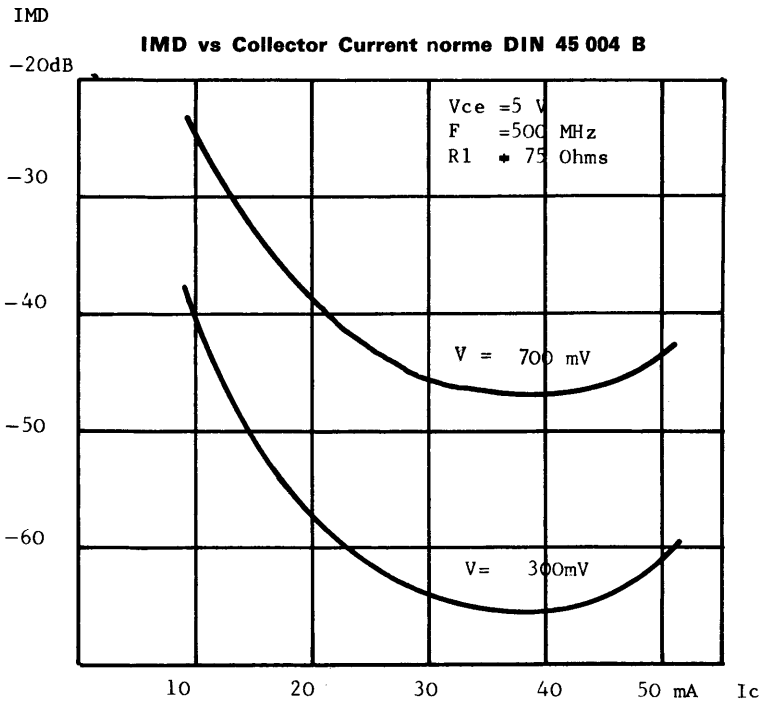


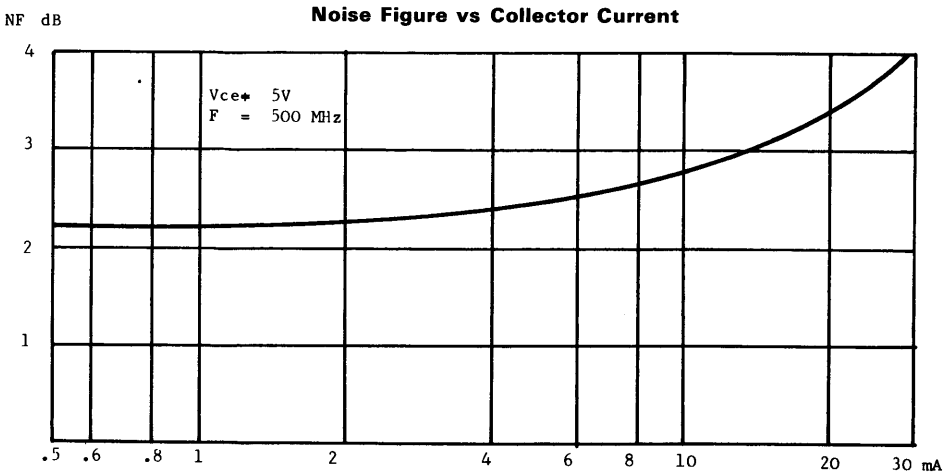
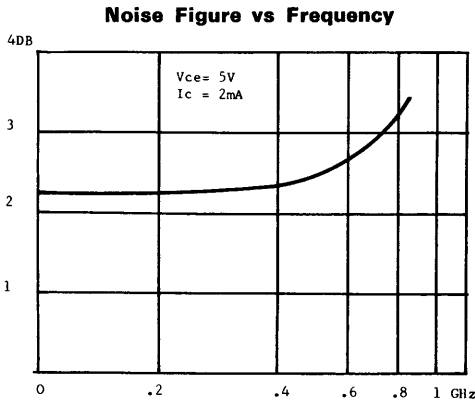
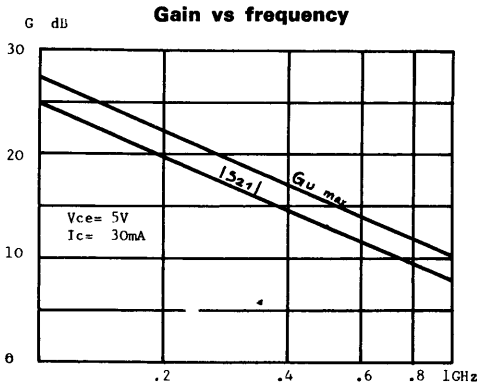
T - PACK

### Electrical Characteristics ( $T_{CASE} = 25\text{ }^{\circ}\text{C}$ )

	SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
DC Test	$BV_{EBO}$	Emitter - Base Breakdown Voltage	$I_E = 0.1\text{ mA}$	2.5			V
	$BV_{CEO}$	Collector - Emitter Breakdown Voltage	$I_C = 10\text{ mA}$	15			V
	$BV_{CBO}$	Collector - Base Breakdown Voltage	$I_C = 0.1\text{ mA}$	25			V
	$h_{FE}$	D.C Current Gain	$V_{CE} = 5\text{ V}$ $I_C = 30\text{ mA}$	25			
RF Test	NF	Noise Figure	$V_{CE} = 5\text{ V}$ $I_C = 2\text{ mA}$ $F = 500\text{ MHz}$		2	2.5	dB
	$f_T$	Cutoff Frequency	$V_{CE} = 5\text{ V}$ $I_C = 30\text{ mA}$ $F = 500\text{ MHz}$	2.8	3.0		GHz
	$G_{Umax}$	Maximum Unilateralized Gain	$V_{CE} = 5\text{ V}$ $I_C = 30\text{ mA}$ $F = 500\text{ MHz}$	15	15.5		dB
	S <sub>21</sub>	Forward Gain 50Ω/50Ω	$V_{CE} = 5\text{ V}$ $I_C = 30\text{ mA}$ $F = 500\text{ MHz}$		14		dB
	IMD	Intermodulation Distortion 3 Tone - Din 45004/B $F = 500\text{ MHz}$ $R_{LOAD} = 75\text{ ohms}$	$V_{CE} = 5\text{ V}$ $V_{out} = 300\text{ mV}$	-60			dB
			$I_C = 30\text{ mA}$ $V_{out} = 700\text{ mV}$	-45			dB
$C_{OB}$	Collector - Base Capacitance	$V_{CB} = 5\text{ V}$ $f = 1\text{ MHz}$		0.7		pF	
Operating Thermal	$I_{Cmax}$	Maximum Collector Current				50	mA
	$P_T$	Dissipated Power				250	mW
	$T_{STG}$	Storage Temperature		-65		+200	$^{\circ}\text{C}$
	$T_j$	Junction Temperature				150	$^{\circ}\text{C}$



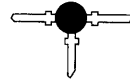




### UHF LINEAR TRANSISTOR

The TP 394 is a NPN transistor, gold metallized for reliability, using diffused ballast resistors for super linearity at currents compatible with the power dissipation capability of a T-Pack. TP 394 is the ideal candidate for up to **0.8 V** (DIN 45004/B) **MATV** amplifiers from **40 to 860 MHz**. The TP 394 has applications in driver stages of 12 volts VHF/UHF transmitters and broadband instrumentation equipment.

**HIGH OUTPUT  
AT LOW COST  
0,7 V AT - 62 DB IMD  
GOLD RELIABILITY  
2,5 GHz FT**

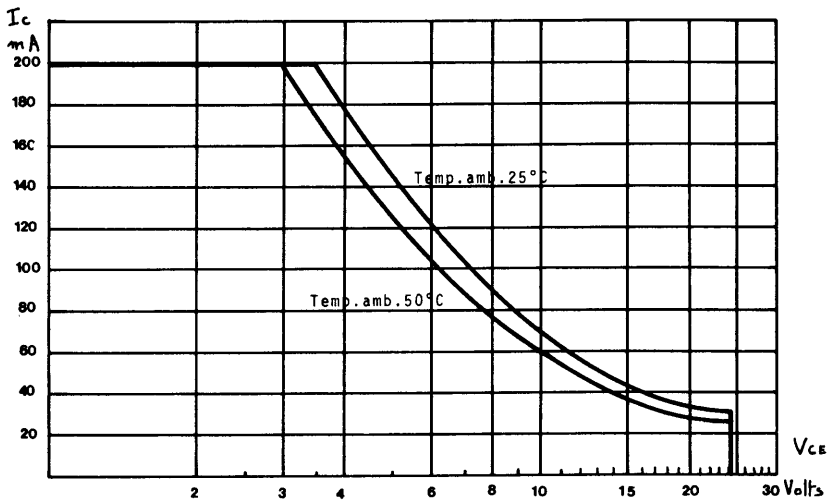


T - PACK

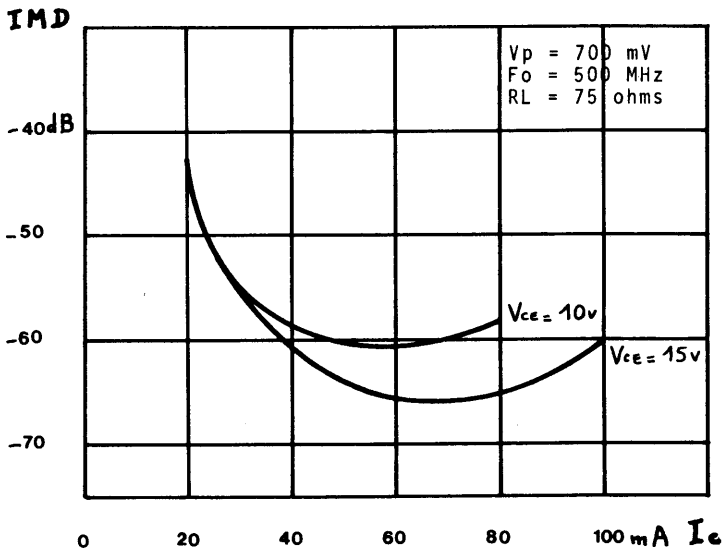
#### Electrical Characteristics (T<sub>CASE</sub> = 25 °C)

	SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT
D C Test	BV <sub>EBO</sub>	Emitter - Base Breakdown Voltage	I <sub>E</sub> = 0.1 mA	3			V
	BV <sub>CEO</sub>	Collector - Emitter Breakdown Voltage	I <sub>C</sub> = 10 mA	25			V
	BV <sub>CER</sub>	Collector - Emitter Breakdown Voltage	I <sub>C</sub> = 10 mA R <sub>BE</sub> = 10 ohms	30			V
	BV <sub>CBO</sub>	Collector - Base Breakdown Voltage	I <sub>C</sub> = 1 mA	35			V
	h <sub>FE</sub>	D.C Current Gain	V <sub>CE</sub> = 10 V I <sub>C</sub> = 40 mA	15			
R F Test	NF	Noise Figure	V <sub>CE</sub> = 10 V I <sub>C</sub> = 20 mA F = 500 MHz		3.5		dB
	f <sub>T</sub>	Cutoff Frequency	V <sub>CE</sub> = 10 V I <sub>C</sub> = 40 mA F = 500 MHz		2.5		GHz
	G <sub>Umax</sub>	Maximum Unilateralized Gain	V <sub>CE</sub> = 10 V I <sub>C</sub> = 40 mA F = 500 MHz		14		dB
	[S 21]	Forward Gain 50 Ω/50 Ω	V <sub>CE</sub> = 10 V I <sub>C</sub> = 40 mA F = 500 MHz		12.5		dB
	IMD	Intermodulation Distortion 3 Tone - DIN 45004/B F = 500 MHz R <sub>Load</sub> = 75 ohms	V <sub>CE</sub> = 10 V I <sub>C</sub> = 60 mA V <sub>out</sub> = 700 mV		- 62		dB
	C <sub>OB</sub>	Collector - Base Capacitance	V <sub>CB</sub> = 10 V f = 1 MHz		2.5		pF
Thermal	I <sub>Cmax</sub>	Maximum Collector Current				200	mA
	P <sub>T</sub>	Dissipated Power	T <sub>CASE</sub> = 50 °C			0.6	W
	T <sub>STG</sub>	Storage Temperature		- 65		+ 200	°C
	T <sub>J</sub>	Junction Temperature					

Safe Operating Area

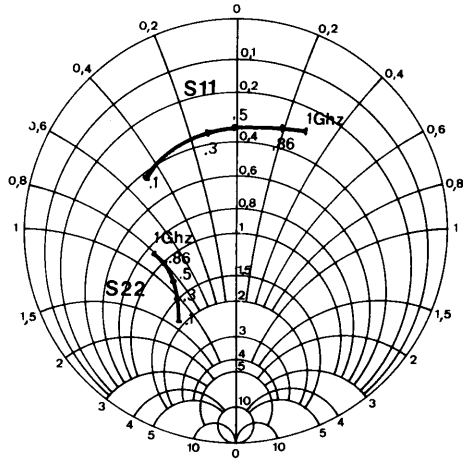


IMD vs  $I_c$  Collector Current



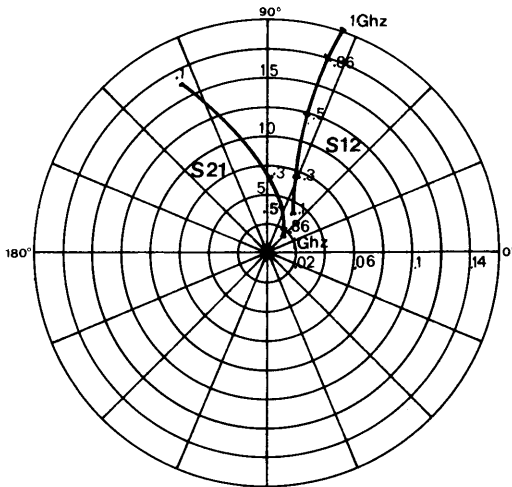
**S11 - S22 Parameters vs Frequency**

$V_{CE} = 10\text{ V} - I_C = 40\text{ mA}$



**S21 - S12 Parameters vs Frequency**

$V_{CE} = 10\text{ V} - I_C = 40\text{ mA}$

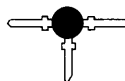


### UHF LINEAR TRANSISTOR

The TP 491 is a gold metallized NPN silicon transistor specifically designed for low noise, high frequency broadband operation, which is mounted in T-pack for high volume low cost applications. These characteristics make it an ideal for low noise, intermediate level **MATV/CATV** amplifiers from **40 to 860 MHz**.

TP 491 has applications in low noise **receivers** and **mixers** up to **2.5 GHz** in radio or cable communication, doppler radars and instrumentation equipments.

**1.6 DB NOISE FIGURE  
AT 500 MHz  
3.5 GHz F<sub>T</sub>  
HIGH OUTPUT**

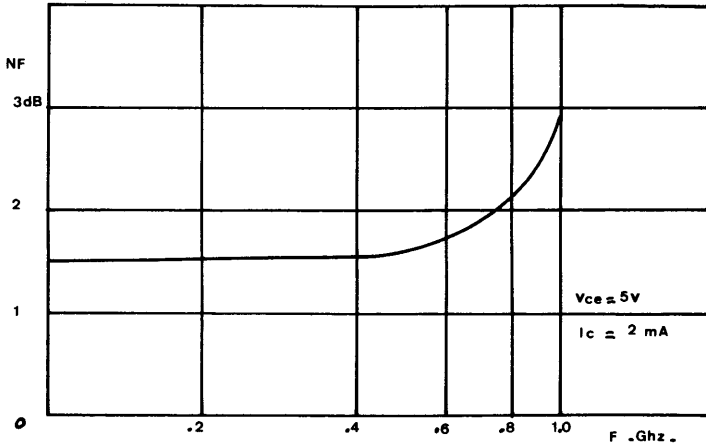


T - PACK

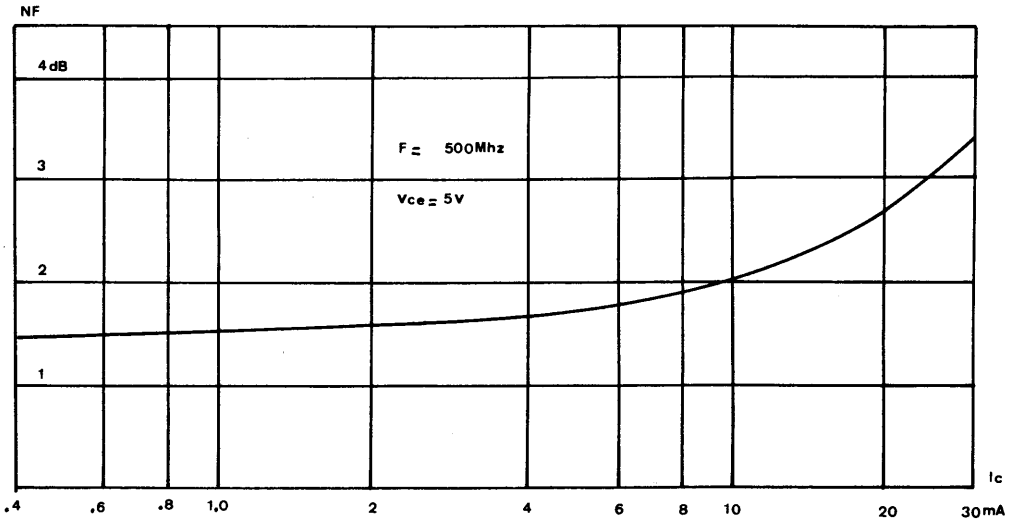
#### Electrical Characteristics (T<sub>flange</sub> = 25 °C)

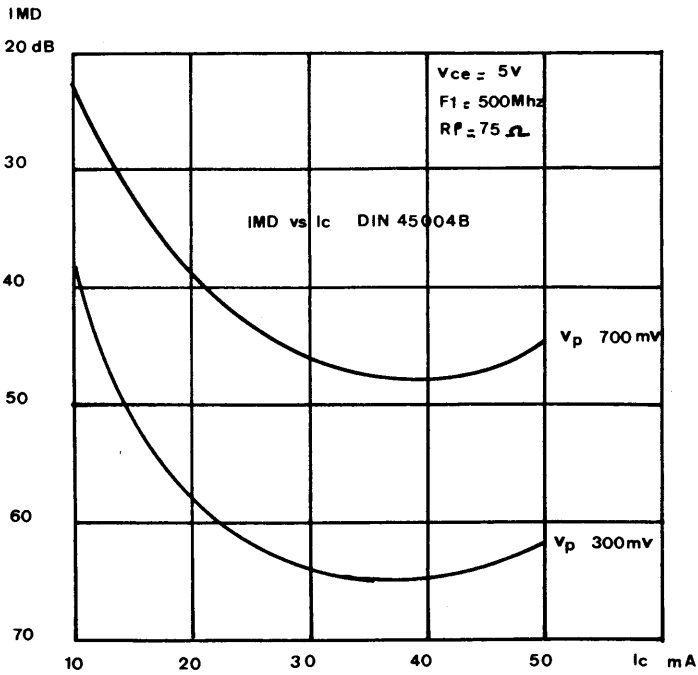
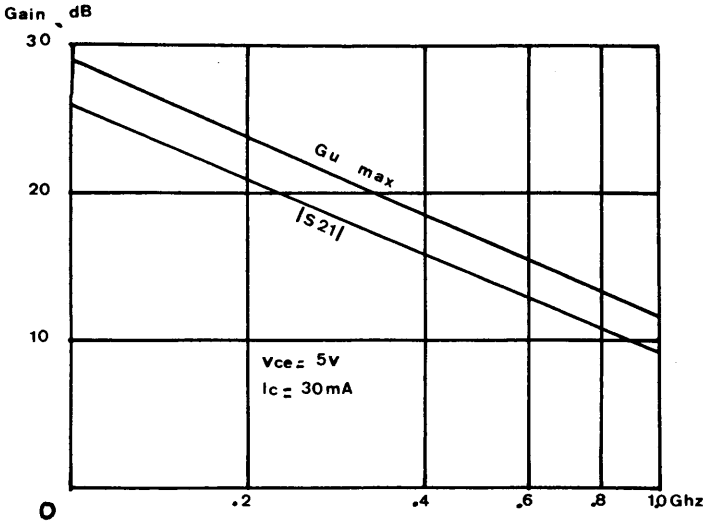
	SYMBOL	CHARACTERISTICS	TEST CONDITIONS	MIN.	TYP.	MAX.	UNIT	
DC Test	BV <sub>EBO</sub>	Emitter - Base Breakdown Voltage	I <sub>E</sub> = 0.1 mA	2.5			V	
	BV <sub>CEO</sub>	Collector - Emitter Breakdown Voltage	I <sub>C</sub> = 10 mA	14			V	
	BV <sub>CBO</sub>	Collector - Base Breakdown Voltage	I <sub>C</sub> = 0.1 mA	25			V	
	I <sub>CBO</sub>	Collector - Base Leakage	V <sub>CB</sub> = 20 V			10	μA	
	h <sub>FE</sub>	D.C. Current Gain	V <sub>CE</sub> = 1 V I <sub>C</sub> = 2 mA	25				
RF Test	NF	Noise Figure	V <sub>CE</sub> = 5 V I <sub>C</sub> = 2 mA F = 500 MHz		1.6	2.0	dB	
	f <sub>T</sub>	Cutoff Frequency	V <sub>CE</sub> = 5 V I <sub>C</sub> = 30 mA F = 500 MHz		3.2		GHz	
	G <sub>Umax</sub>	Maximum Unilateralized Gain	V <sub>CE</sub> = 5 V I <sub>C</sub> = 30 mA F = 500 MHz		16.4		dB	
	S <sub>21</sub>	Forward Gain 50 Ω/50 Ω	V <sub>CE</sub> = 5 V I <sub>C</sub> = 30 mA F = 500 MHz		14.8		dB	
	IMD	Intermodulation Distortion 3 Tone - Din 45004/B F = 500 MHz R <sub>LOAD</sub> = 75 ohms	V <sub>CE</sub> = 5 V	V <sub>out</sub> = 300 mV			- 60	dB
			I <sub>C</sub> = 30 mA	V <sub>out</sub> = 700 mV			- 45	dB
C <sub>OB</sub>	Collector - Base Capacitance	V <sub>CB</sub> = 5 V f = 1 MHz		0.8		pF		
Thermal	I <sub>Cmax</sub>	Maximum Collector Current				50	mA	
	P <sub>T</sub>	Dissipated Power				300	mW	
	T <sub>STG</sub>	Storage Temperature						
	T <sub>J</sub>	Junction Temperature		- 65		+ 200	°C	

Noise Figure vs Frequency



Noise Figure vs Collector Current

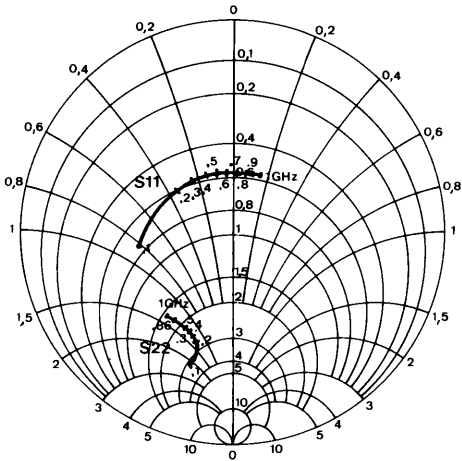






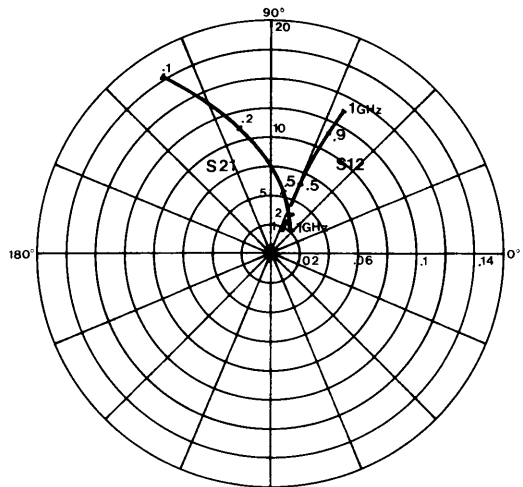
**S11 - S22 Parameters vs Frequency**

$V_{CE} = 5\text{ V} - I_C \cong 30\text{ mA}$



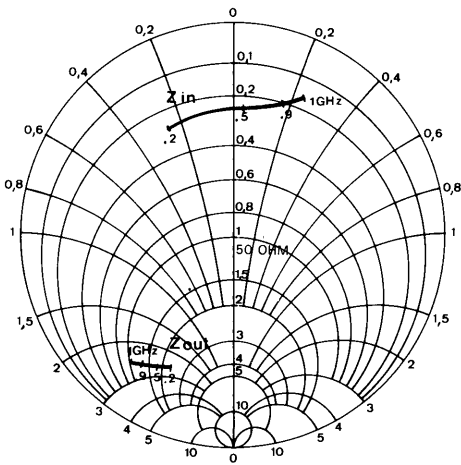
**S21 - S12 Parameters vs Frequency**

$V_{CE} = 5\text{ V} - I_C = 30\text{ mA}$



**$Z_{in}$   $Z_{out}$  from « S » Parameters**

$V_{CE} = 5\text{ V} - I_C = 30\text{ mA}$



**PACKAGE OUTLINE**

